

Title (en)

Method of fabrication of electronic devices using microfluidic channels

Title (de)

Methode, elektronische Anordnungen mittels Mikrokanälen herzustellen

Title (fr)

Méthode de fabrication de dispositifs semiconducteur par des micro-canaux

Publication

EP 1422766 A3 20070606 (EN)

Application

EP 03026733 A 20031121

Priority

US 30355102 A 20021122

Abstract (en)

[origin: EP1422766A2] A structure and method of using microfluidic channels to form an array of semiconductor devices is described. The microfluidic channels have been found to be particularly useful when formed in a self aligned process and used to interconnect a series of thin film transistor (TFT) devices.

IPC 8 full level

G03F 7/20 (2006.01); **H01L 21/336** (2006.01); **H01L 29/786** (2006.01); **H10K 99/00** (2023.01)

CPC (source: EP US)

H10K 19/10 (2023.02 - EP US); **H10K 71/12** (2023.02 - EP US); **H10K 71/20** (2023.02 - EP US); **H10K 71/60** (2023.02 - EP US);
H10K 10/462 (2023.02 - EP US)

Citation (search report)

- [X] WO 0195384 A1 20011213 - UNIV LIVERPOOL [GB], et al
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- [X] US 6452207 B1 20020917 - BAO ZHENAN [US]
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WO2013065276A1; EP2122690A4; WO2010042170A3; WO2006120414A3

Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PT RO SE SI SK TR

Designated extension state (EPC)

AL LT LV MK

DOCDB simple family (publication)

EP 1422766 A2 20040526; **EP 1422766 A3 20070606**; **EP 1422766 B1 20110119**; BR 0305303 A 20040831; CA 2449632 A1 20040522;
CA 2449632 C 20090707; DE 60335772 D1 20110303; JP 2004179655 A 20040624; JP 4699687 B2 20110615; US 2004101987 A1 20040527;
US 6872588 B2 20050329

DOCDB simple family (application)

EP 03026733 A 20031121; BR 0305303 A 20031121; CA 2449632 A 20031117; DE 60335772 T 20031121; JP 2003390153 A 20031120;
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